

**Robert Lutwak – Symmetricom Technology Realization Center**

**DARPA MTO Technology Symposium  
March 5, 2007  
San Jose, CA**



# Report Documentation Page

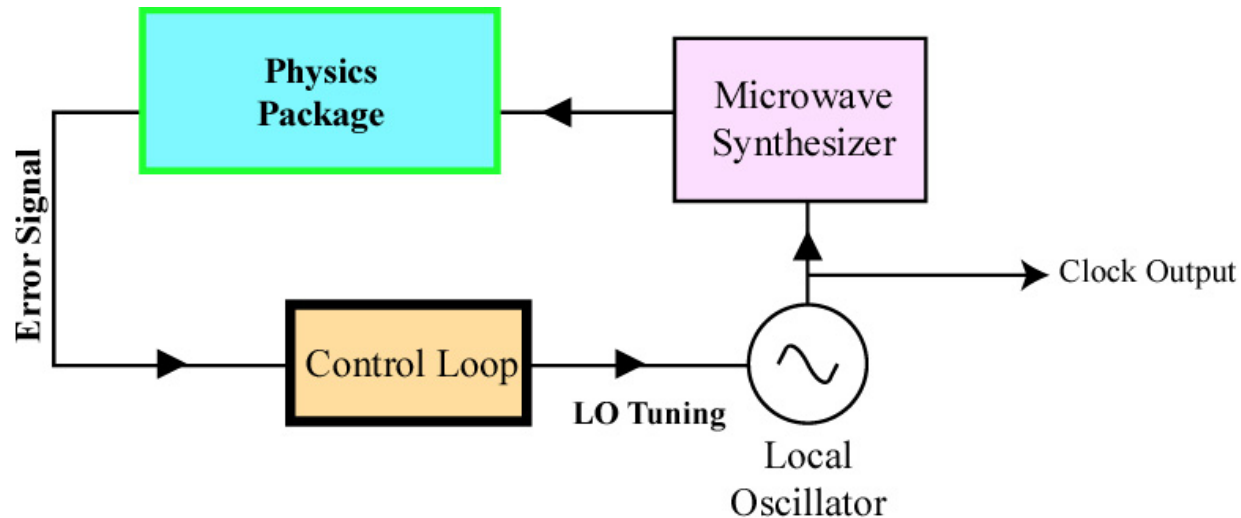
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  - DARPA-MTO Contract No. NBCHC020050

# What is an atomic clock?



Atomic resonance is intrinsically more stable than quartz local oscillator

“*Natural*” atomic microwave resonance frequency is synthesized from RF LO

Control Loop continuously steers LO frequency to atomic resonance

RF output (*10 MHz*) embodies stability of atomic resonance

# Conventional Atomic Clocks



Active Hydrogen Maser  
375,000 cm<sup>3</sup>  
100 Watts  
Excellent short-term stability

Cesium Beam Frequency Standard  
30,000 cm<sup>3</sup>  
50 Watts  
Excellent long-term stability/accuracy



Rubidium Oscillator  
500 cm<sup>3</sup>  
10 Watts  
Compact and cost-effective

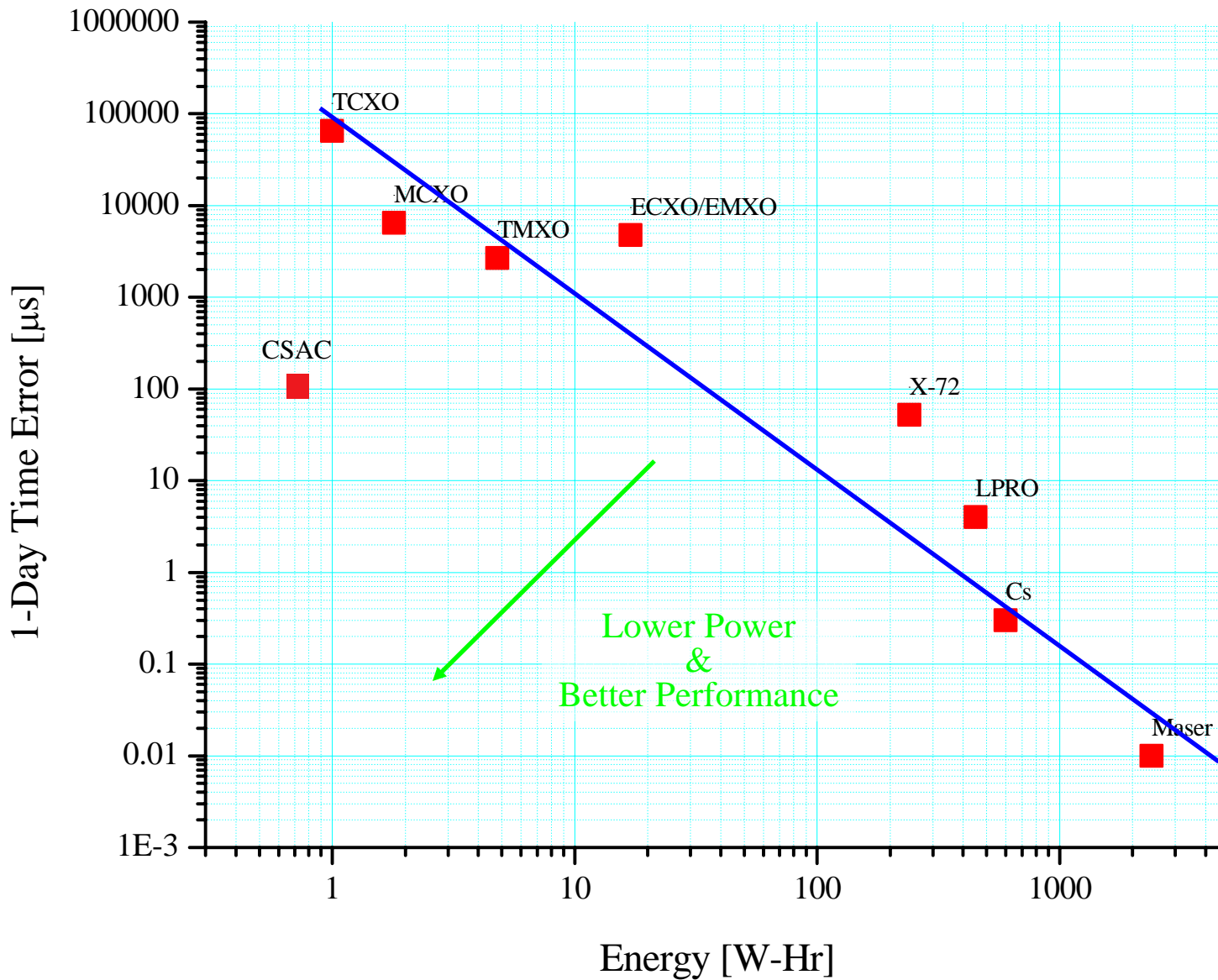
# The Chip-Scale Atomic Clock



- ▶ DARPA MTO-funded effort to produce accurate timing sources for portable instruments
  - Time-Sequence Code Acquisition for Secure Communications
  - GPS Direct P(y) Code Acquisition
  
- ▶ Key Specifications
  - Device Volume:  $< 1\text{cm}^3$
  - Total Power Consumption:  $< 30\text{ mW}$
  - Stability:  $\sigma_y(\tau = 1\text{ hr}) < 1 \times 10^{-11}$
  
- ▶ Two orders of magnitude smaller and lower power than current atomic clock technology



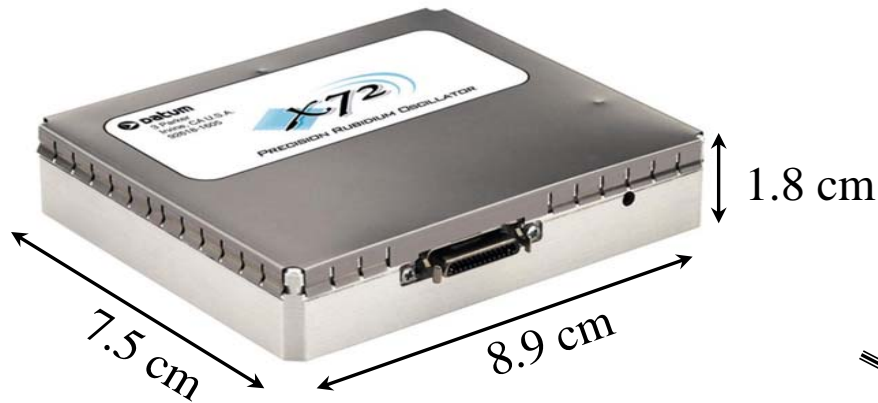
# The CSAC Challenge



# Small low-power atomic clocks

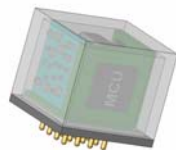


## X72



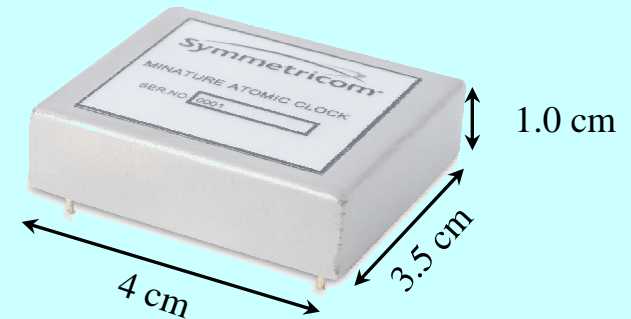
Smallest production atomic clock  
Volume  $\approx 125 \text{ cm}^3$   
Power  $\approx 8 \text{ W}$   
Stability  $< 3 \times 10^{-11}$  @ 1 second

## CSAC Objective



Volume  $\approx 1 \text{ cm}^3$   
Power  $\approx 30 \text{ mW}$   
Stability  $< 6 \times 10^{-10}$  @ 1 second

## CSAC Prototype Miniature Atomic Clock - "MAC"



Volume  $\approx 16 \text{ cm}^3$   
Power  $\approx 125 \text{ mW}$   
Stability  $\approx 3 \times 10^{-10}$  @ 1 second



## ▶ Multiple Competitive Contracts

- Symmetricom/Draper/Sandia
- National Institute of Standards and Technology (NIST)/U. of Colorado
- Teledyne Scientific/Rockwell Collins/Agilent
- Honeywell
- Sarnoff/Princeton/Frequency Electronics

**YOU ARE HERE**

## ▶ Three-Phase Program:

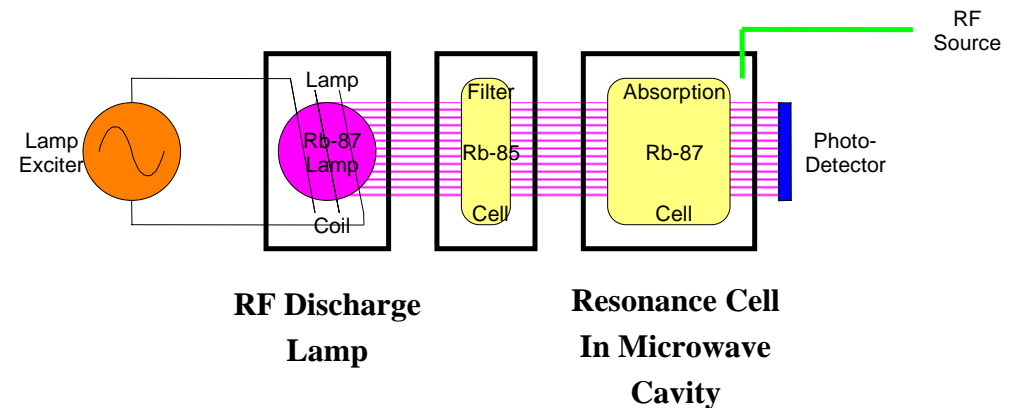
- Phase-I (2002-2003) – Physics and feasibility
- Phase-II (2003-2005) – Intermediate size/power prototype
- Phase-III (2005-2007) – Design Verification and size/power reduction
- Phase-IV (?) – Environmental Ruggedization, production engineering, and System Integration



- ▶ **Physics Package (10 mW)**
  - Must be heated to  $T > 75^\circ\text{C}$  to vaporize (alkali metal) atoms
    - Thermal isolation – *Convection, Conduction, Radiation*
    - Overhead head load – *Low-power-dissipation VCSEL*
  - Mechanical Robustness
    - Shock and vibration resistance for handheld (dropped) applications
- ▶ **Microwave System (10 mW)**
  - Phase noise at microwave frequency (4.6 GHz) must support Signal/Noise
  - Short-term stability at  $\tau < \tau_{\text{LOOP}}$  must support STS objective
- ▶ **Control Systems (10 mW)**
  - Short-term stability – *Low-noise components, Optimum interrogation*
  - Long-term stability – *“Independent” stabilization of interrogation environment*
    - Atom density and buffer gas environment, optical power and spectrum
- ▶ **Value**
  - Size, power, stability
  - ...long-term stability...environmental stability...ease of integration...cost...

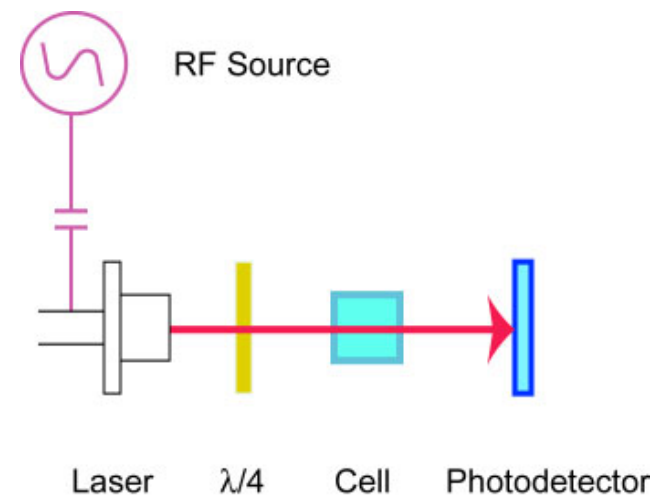
## Conventional Rb Physics

- Requires resonant microwave cavity
- RF Discharge lamp (*1 Watt*)
- 3 (2?) cells, ovens, controllers

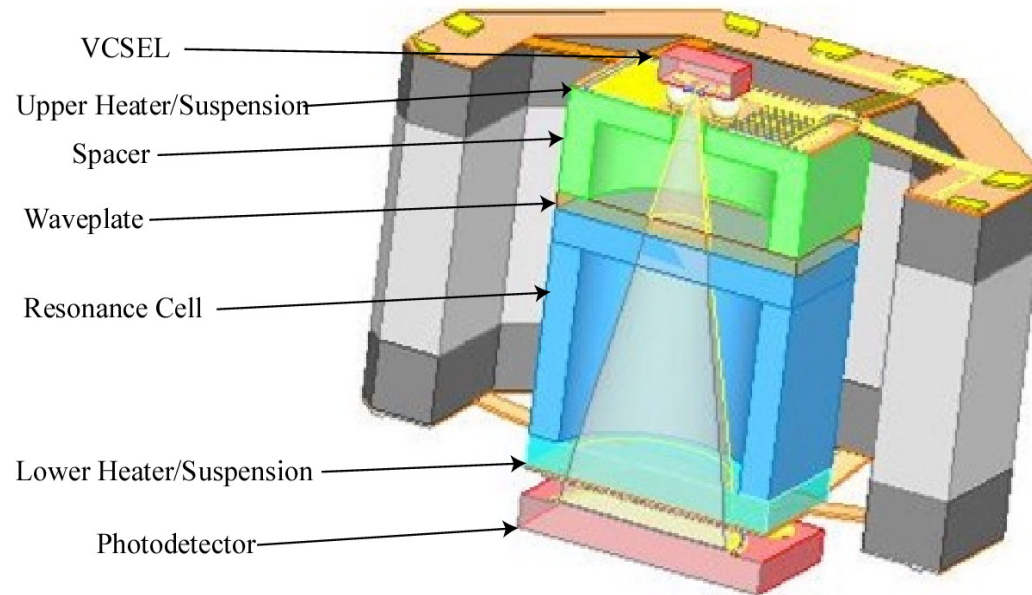


## Coherent Population Trapping (CPT) Physics

- High-bandwidth Vertical-Cavity Surface Emitting Laser (*VCSEL*)
- Microwaves applied directly to VCSEL (*No cavity*)
- Potential for very small oven assembly

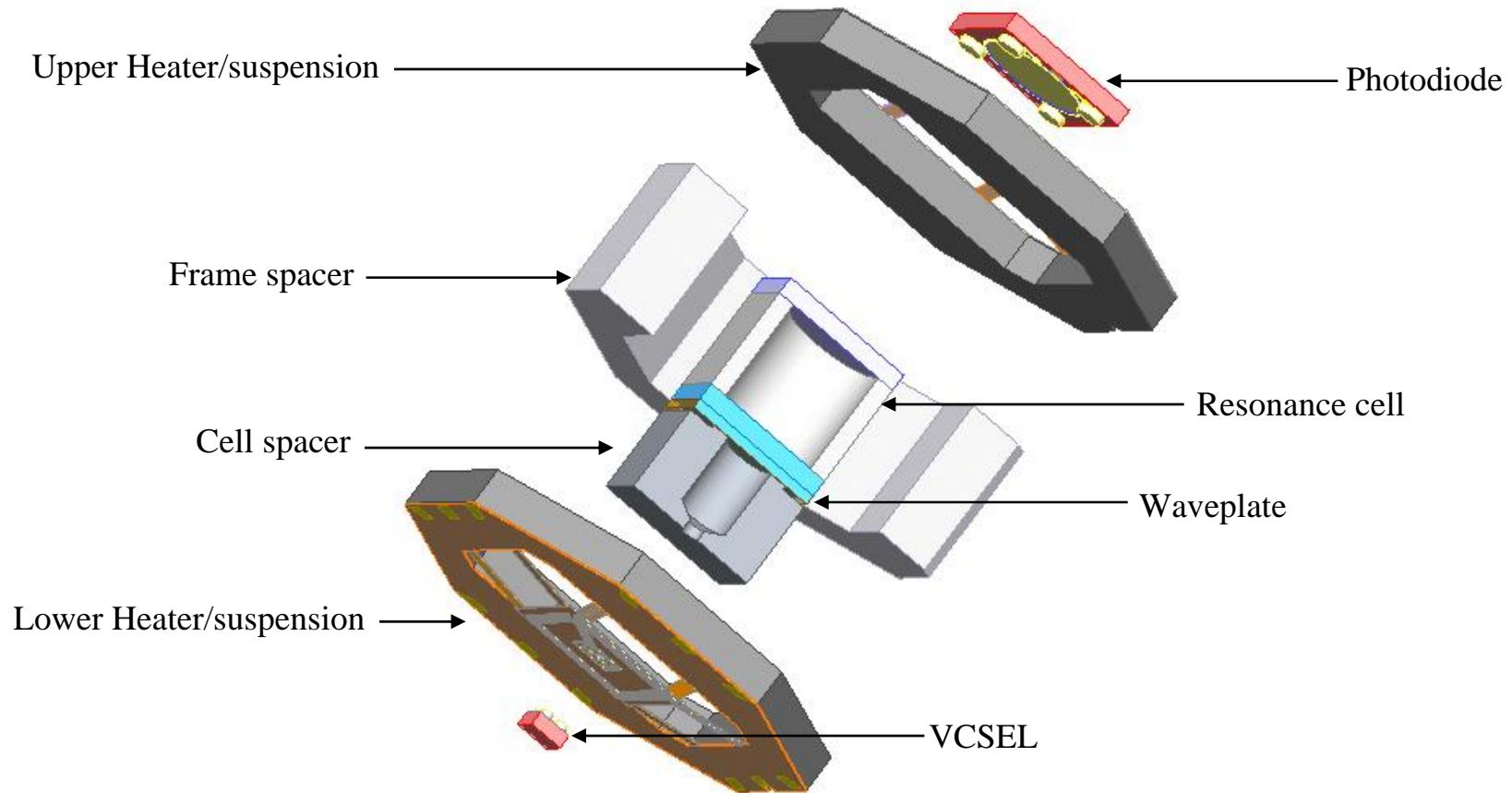


# The 10 mW Physics Package

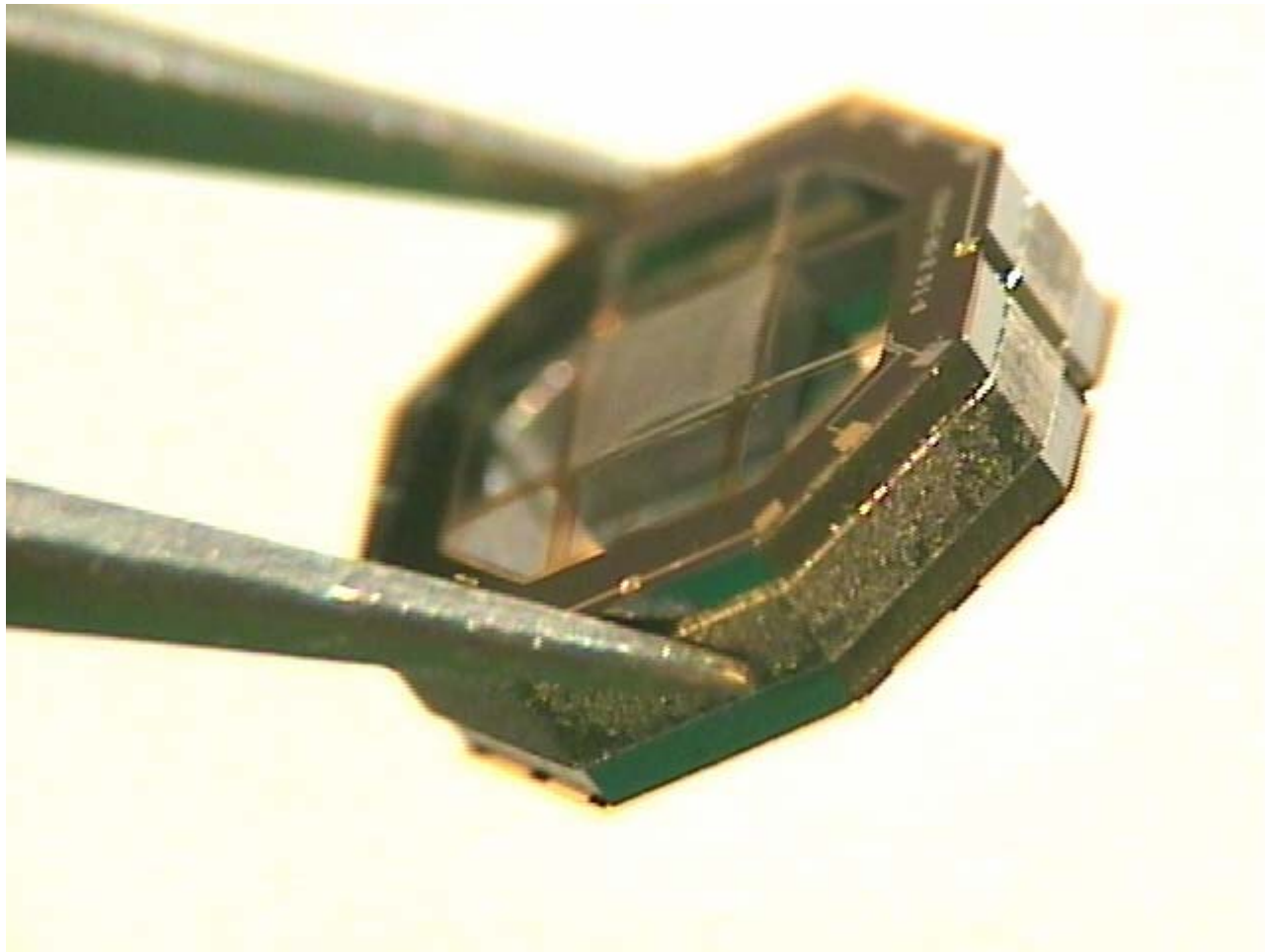


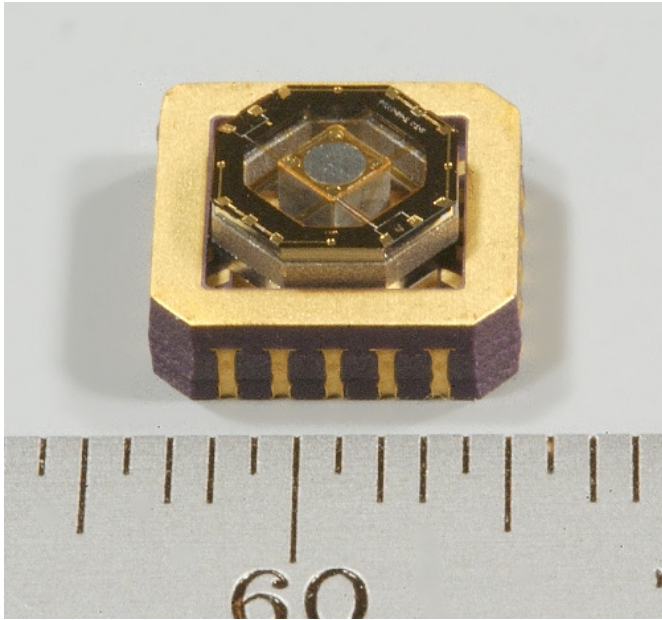
- ▶ Tensioned polyimide suspension
- ▶ Microfabricated Silicon vapor cell
- ▶ Low-power Vertical-Cavity Surface Emitting Laser (VCSEL)
- ▶ Vacuum-packaged to eliminate convection/conduction
- ▶ Overall Thermal Resistance  $7000^{\circ}\text{C}/\text{W}$

# Physics Package Assembly

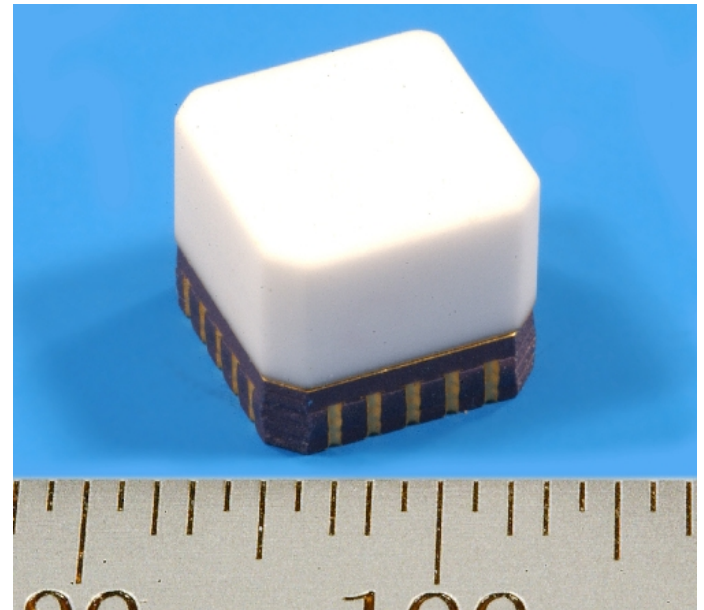


# Physics Package



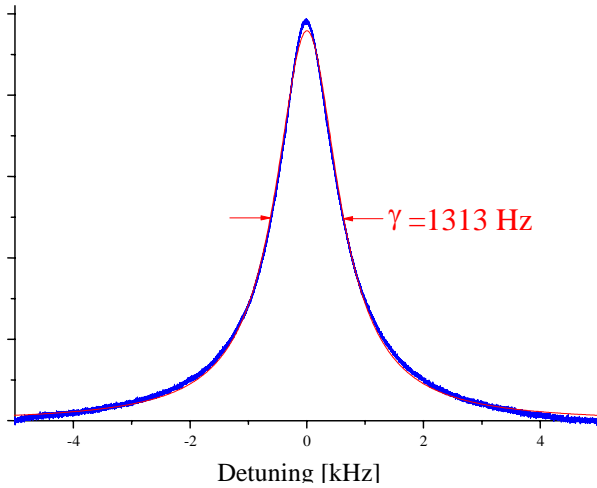


Physics package in LCC



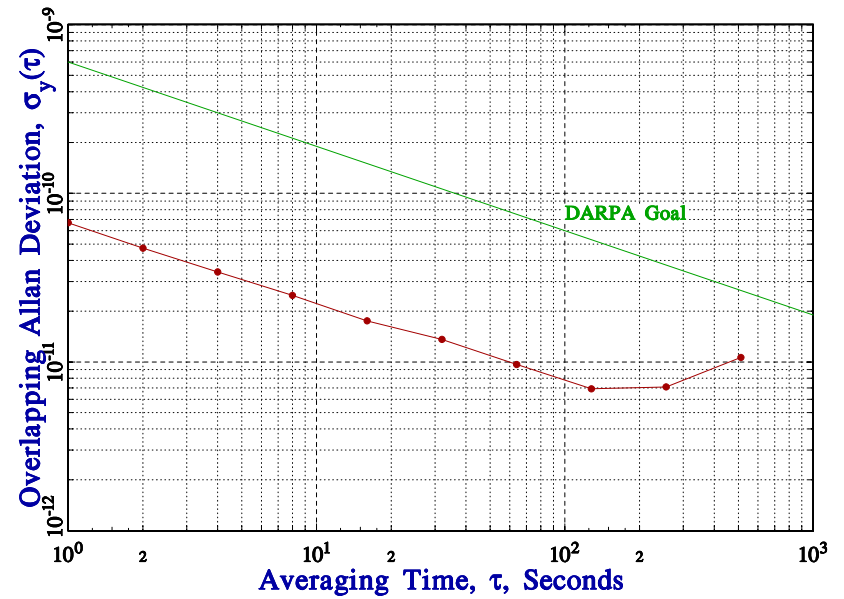
Vacuum sealed

### CPT Resonance @ 4.6 GHz



Resonance "Q" =  $4 \times 10^6$

### Stability vs. Time

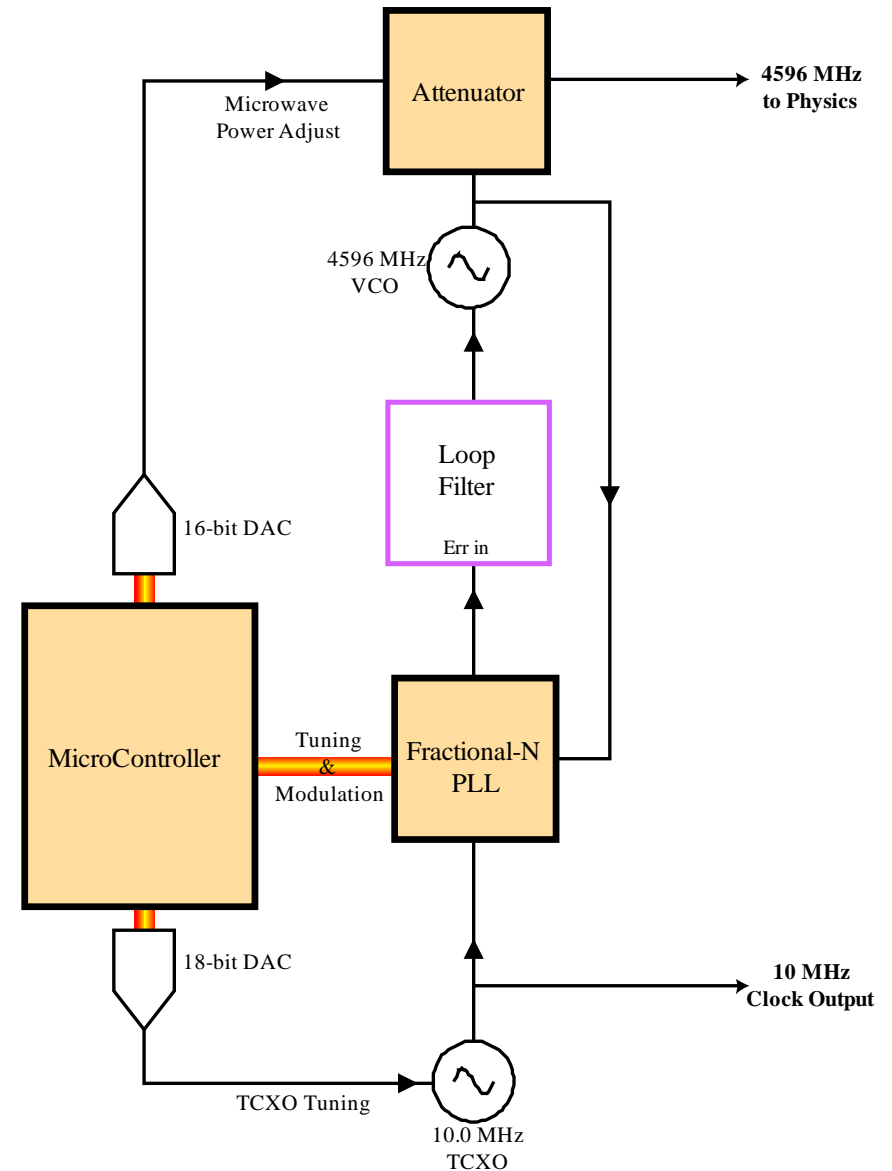




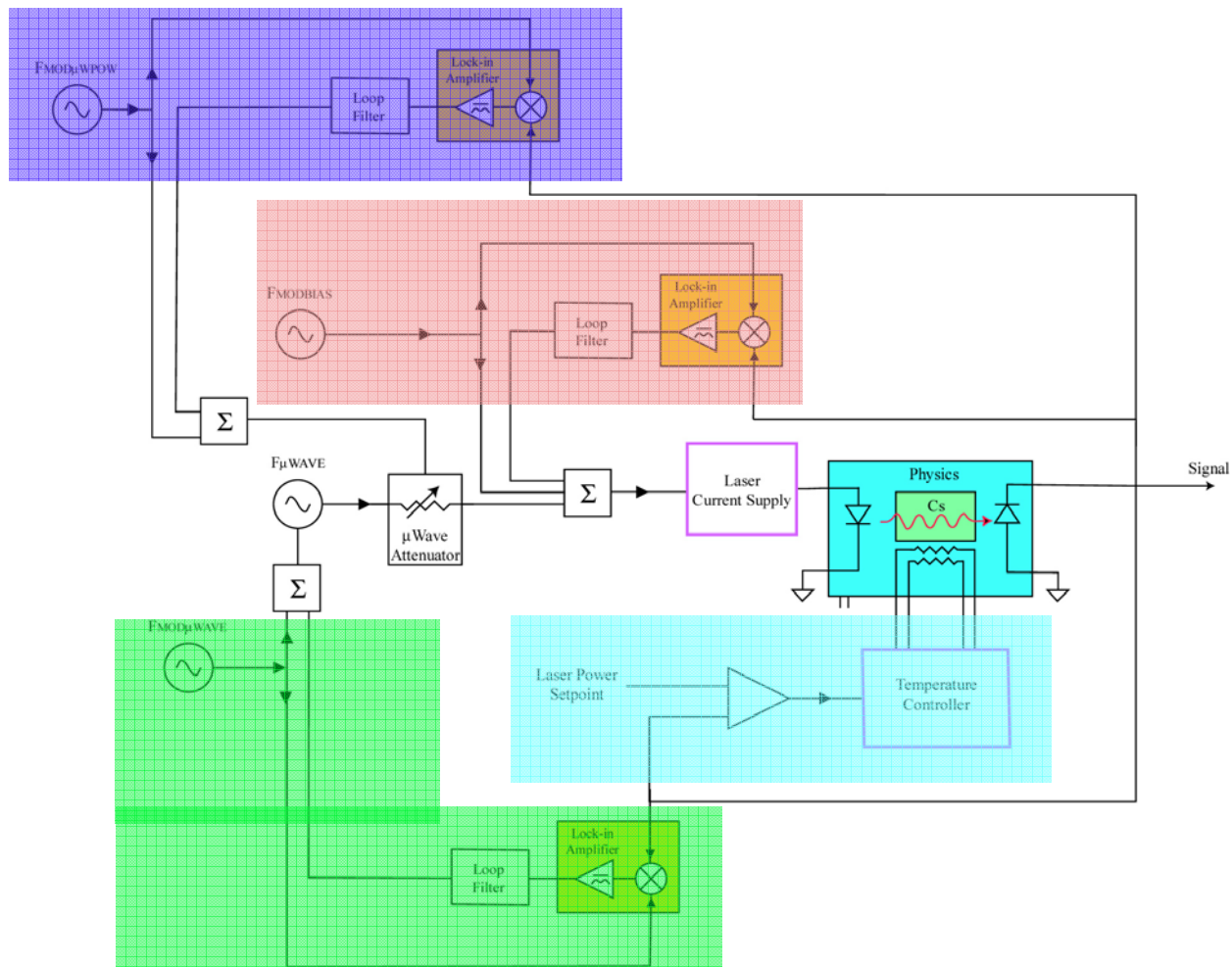
# Microwave Synthesizer



- ▶ TCXO Output at 10 MHz
  - ▶ Atomic Interrogation at 4596 MHz
  - ▶ Fractional-N PLL
  - ▶ Modulation via digital control of PLL
  - ▶ Tuning via digital control of PLL
- Resolution:  $2 \times 10^{-12}$



# Control System



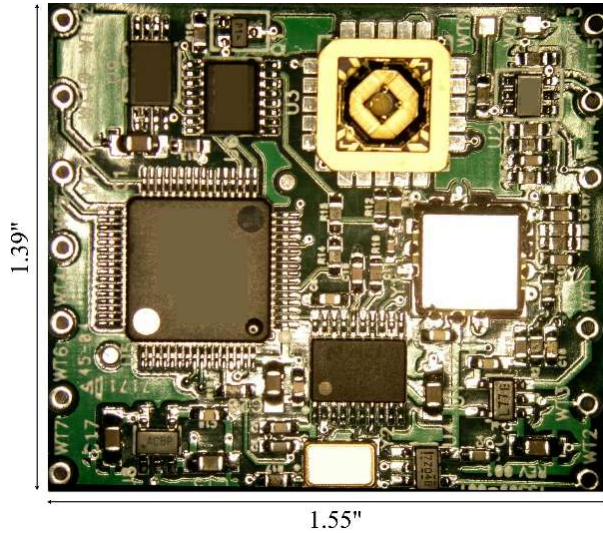
Laser Servo - Lock laser wavelength to optical absorption resonance via DC Bias

Temperature Servo - Optimize optical power via temperature

Clock Servo - Lock local oscillator to CPT resonance

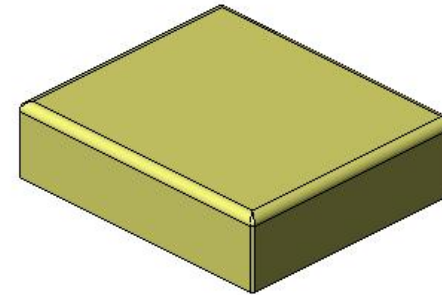
Power Servo - Optimize CPT signal amplitude via  $\mu$ Wave power

# Control Electronics

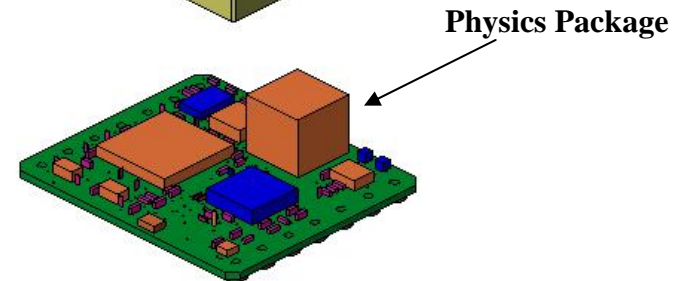


<b>Microwave System: 60 mW</b>
<b>Control System: 40 mW</b>
<b>Physics: 10 mW</b>
<b>Regulators &amp; Passives: 15 mW</b>
<hr/>
<b>Total: 125 mW</b>

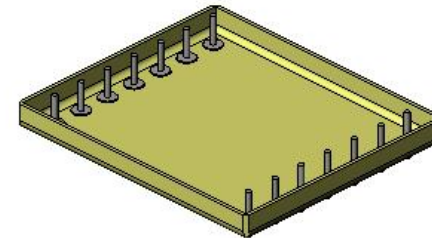
Upper  $\mu$ Metal Housing



Main Clock Board



Lower  $\mu$ Metal Housing



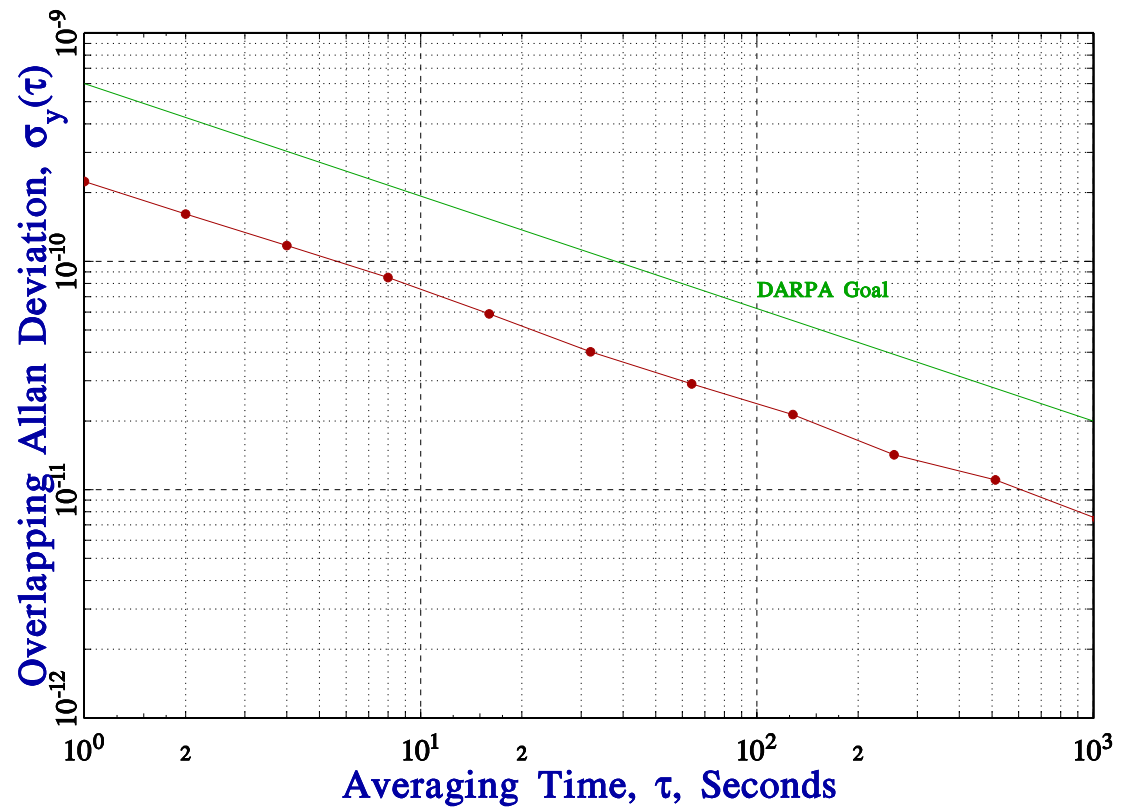
# Typical Prototype Performance



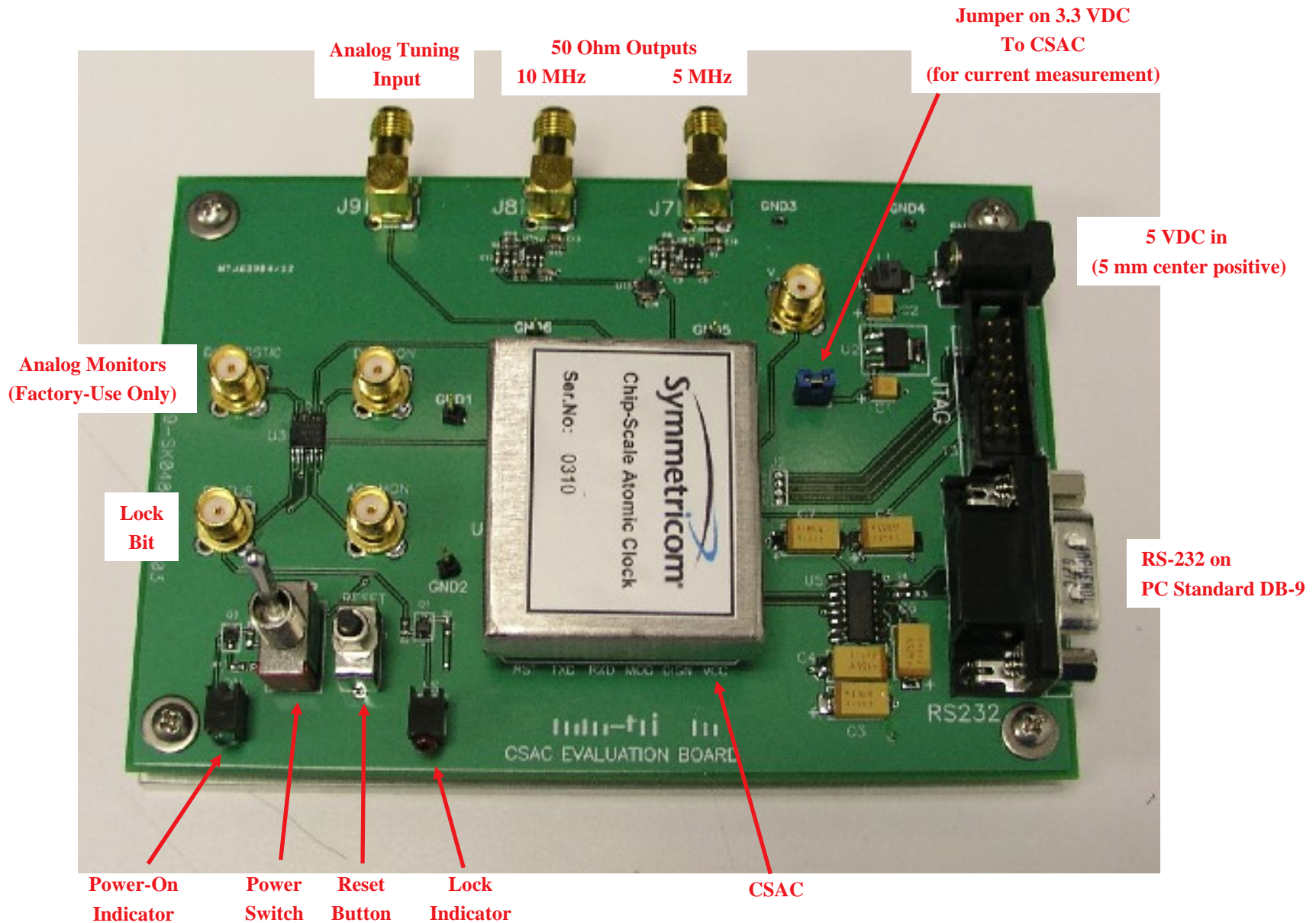
Size  $\approx 15 \text{ cm}^3$

Power  $\approx 125 \text{ mW}$

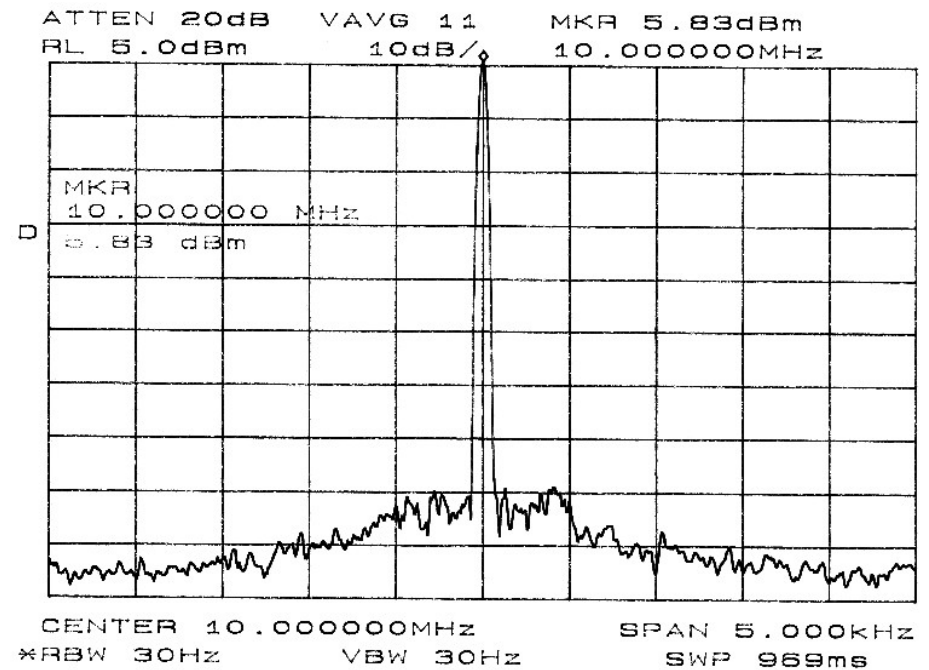
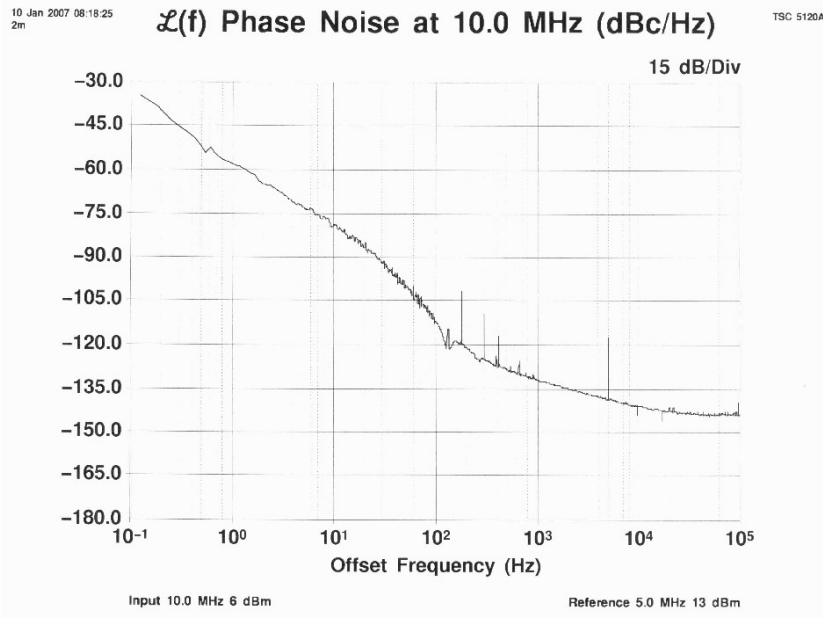
Stability  $\approx 2\text{-}3 \times 10^{-10} \tau^{-1/2}$



# CSAC Prototype on Evaluation Board



# 10 MHz Clock Output



## 1) Build and Test 10 Prototype Units

- Measure long-term aging
- Statistical variation of STS, TempCo, aging, retrace, etc.
- Deliver to systems integrators and independent testing facilities
- Support systems-level demonstrations

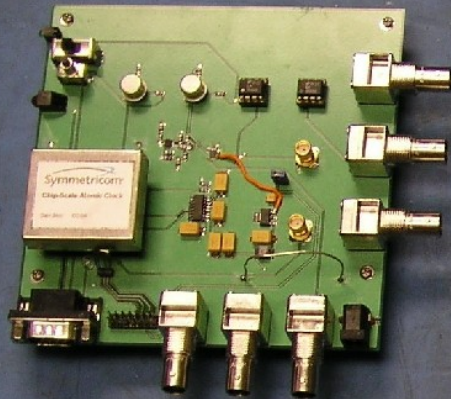
## 2) Reduce Size and Power

- Develop smaller physics package
- Develop low-power microwave oscillator
- Test and incorporate lower-power active components

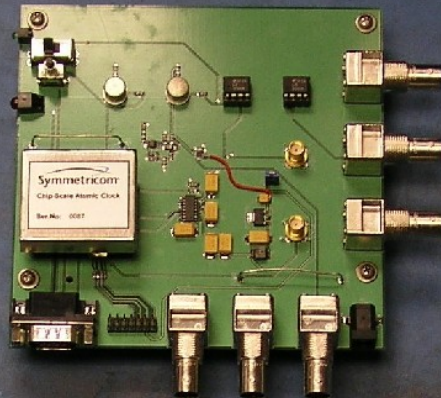
# Prototype CSACs



SN084



SN087



SN309



SN310



SN312



SN313

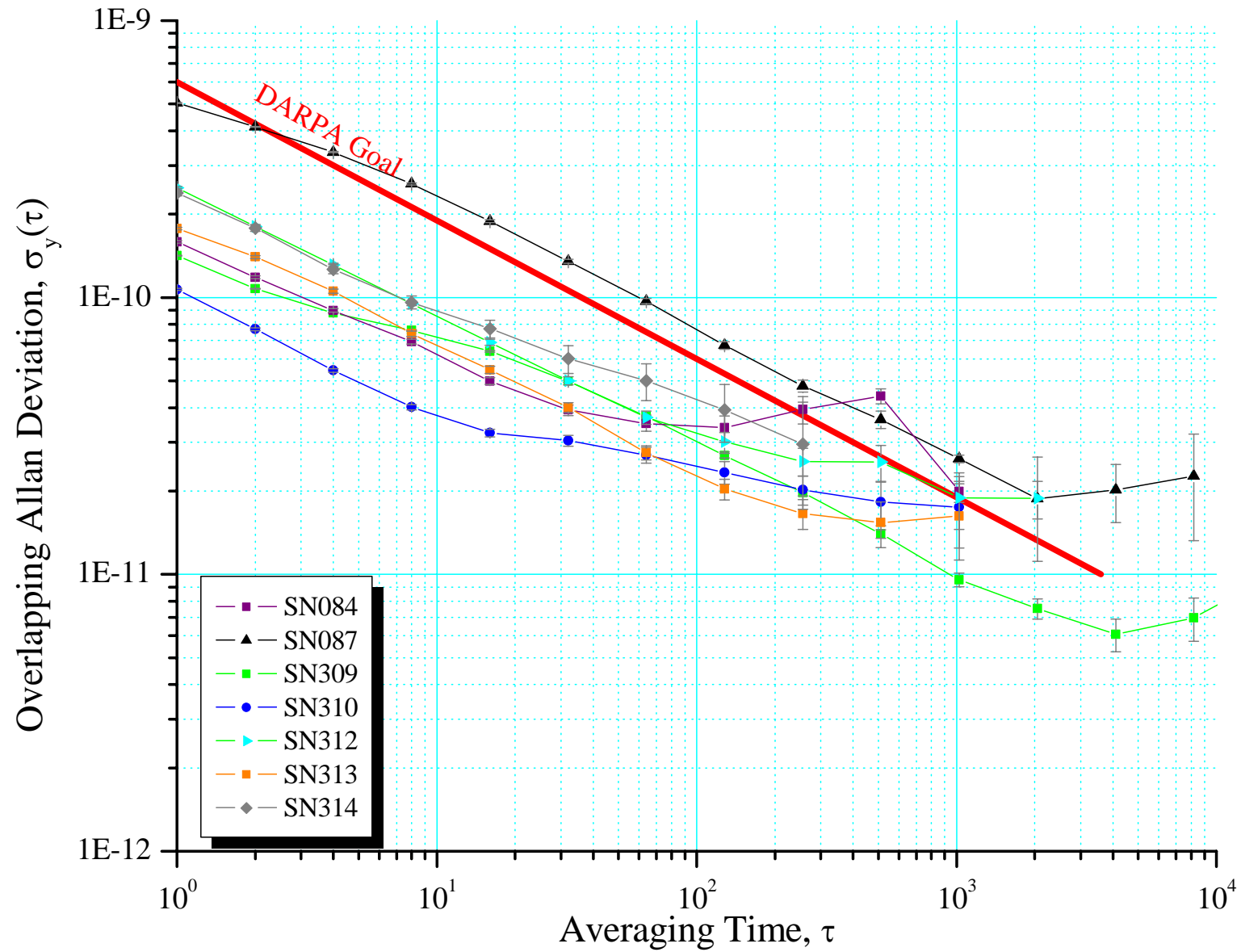


SN314





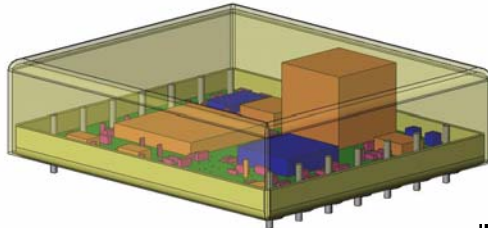
# Short-Term Stability



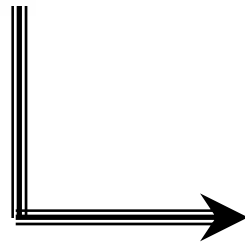
# Evolutionary Path to 30 mW/1 cm<sup>3</sup>



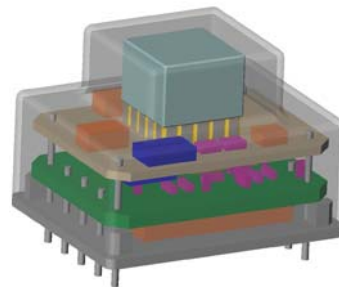
Current Prototype



15 cm<sup>3</sup>  
125 mW



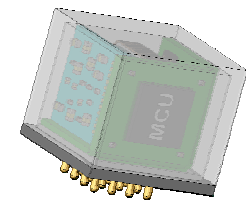
Small Low-Power Prototype



3 cm<sup>3</sup> (including 0.35 cm<sup>3</sup> physics package)  
30 mW (4.6 GHz Output)  
50 mW (10.0 MHz Output)



Tiny Micro-Power

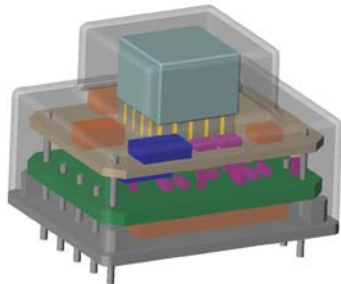


1 cm<sup>3</sup>  
30 mW

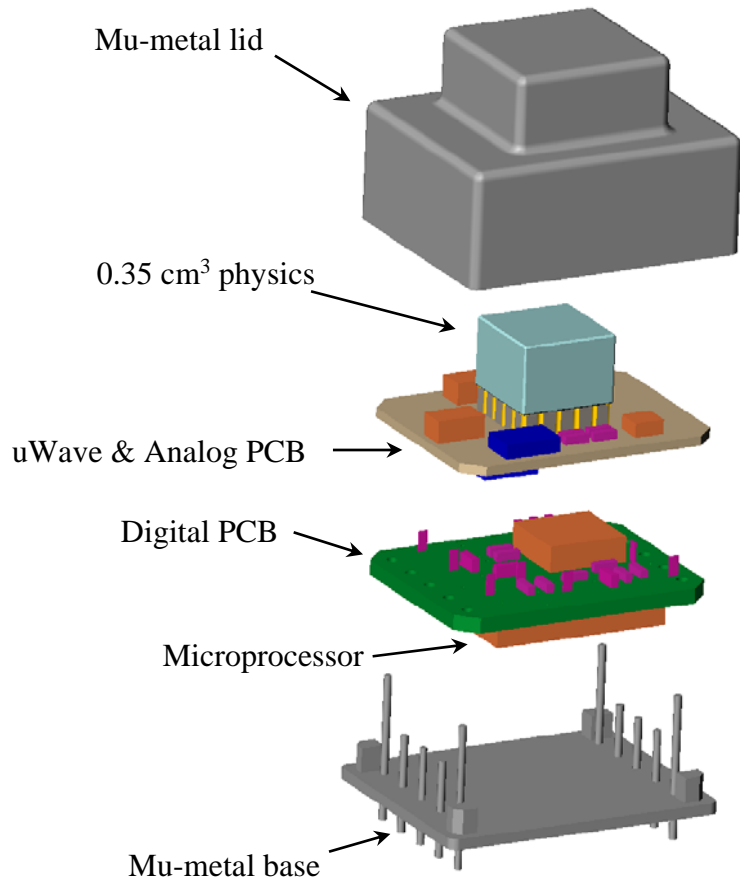
# 4 cm<sup>3</sup> CSAC



## Small Low-Power Prototype

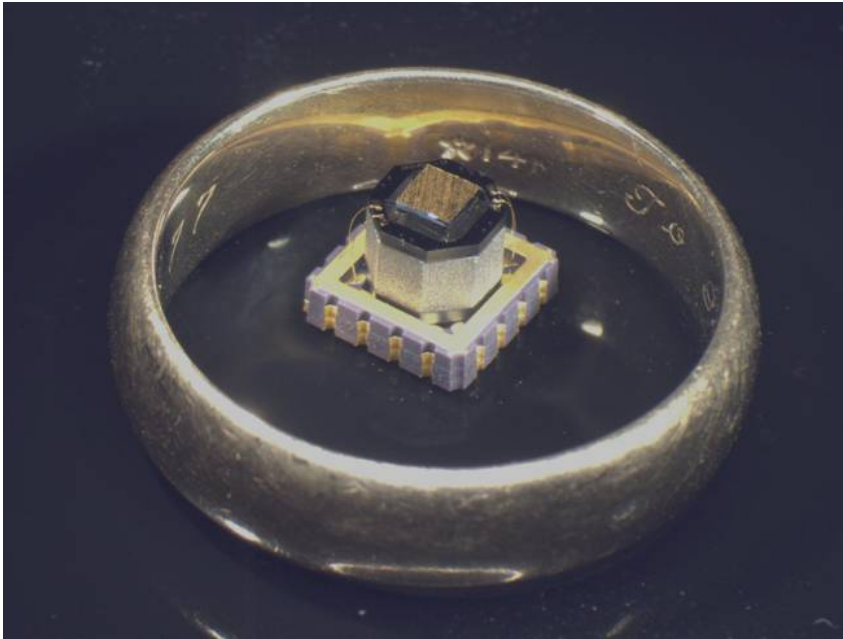


3.8 cm<sup>3</sup> (including 0.35 cm<sup>3</sup> physics package)  
30 mW (4.6 GHz Output, no Vreg)  
60 mW (10.0 MHz Output, Vreg)



**4 cm<sup>3</sup>**  
**Prototype Concept**

# 0.35 cm<sup>3</sup> Physics Package



First prototype build 11/2006.  
Demonstrated 85°C operation w/10 mW heater power  
Fixture development underway

